

2SB1202/2SD1802

ELECTRICAL CHARACTERISTICS at $T_A = 25^\circ\text{C}$

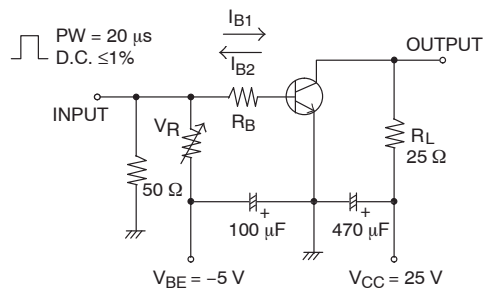
Parameter	Symbol	Conditions	Ratings			Unit
			Min	Typ	Max	
Collector Cutoff Current	I_{CBO}	$V_{CB} = (-)40\text{ V}, I_E = 0\text{ A}$			(-)1	μA
Emitter Cutoff Current	I_{EBO}	$V_{EB} = (-)4\text{ V}, I_C = 0\text{ A}$			(-)1	μA
DC Current Gain	h_{FE1}	$V_{CE} = (-)2\text{ V}, I_C = (-)100\text{ mA}$	100*		560*	
	h_{FE2}	$V_{CE} = (-)2\text{ V}, I_C = (-)3\text{ A}$	35			
Gain-Bandwidth Product	f_T	$V_{CE} = (-)10\text{ V}, I_C = (-)50\text{ mA}$		150		MHz
Output Capacitance	C_{ob}	$V_{CB} = (-)10\text{ V}, f = 1\text{ MHz}$		(39)25		pF
Collector to Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C = (-)2\text{ A}, I_B = (-)100\text{ mA}$		(-0.35)0.19	(-0.7)0.5	V
Base to Emitter Saturation Voltage	$V_{BE(sat)}$	$V_{CE} = (-)2\text{ V}, I_C = (-)100\text{ mA}$		(-)0.94	(-)1.2	V
Collector to Base Breakdown Voltage	$V_{(BR)CBO}$	$I_C = (-)10\text{ }\mu\text{A}, I_E = 0\text{ A}$	(-)60			V
Collector to Emitter Breakdown Voltage	$V_{(BR)CEO}$	$I_C = (-)1\text{ mA}, R_{BE} = \Omega$	(-)50			V
Emitter to Base Breakdown Voltage	$V_{(BR)EBO}$	$I_E = (-)10\text{ }\mu\text{A}, I_C = 0\text{ A}$	(-)6			V
Turn-On Time	t_{on}	See specified Test Circuit		70		ns
Storage Time	t_{stg}			(450)650		ns
Fall Time	t_f			35		ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

*The 2SB1202/2SD1802 are classified by 100 mA h_{FE} as follows :

Rank	R	S	T	U
h_{FE}	100 to 200	140 to 280	200 to 400	280 to 560

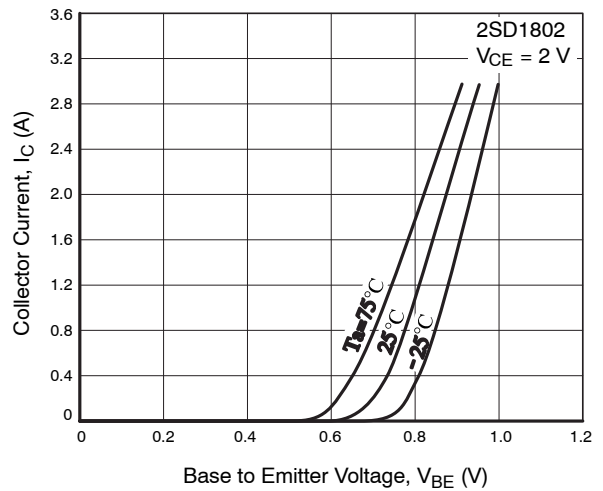
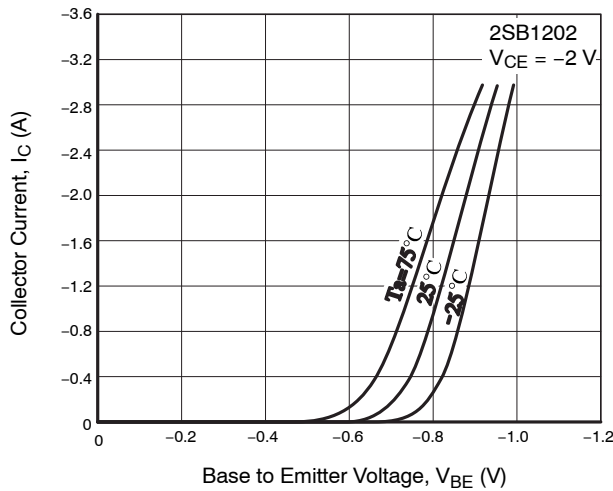
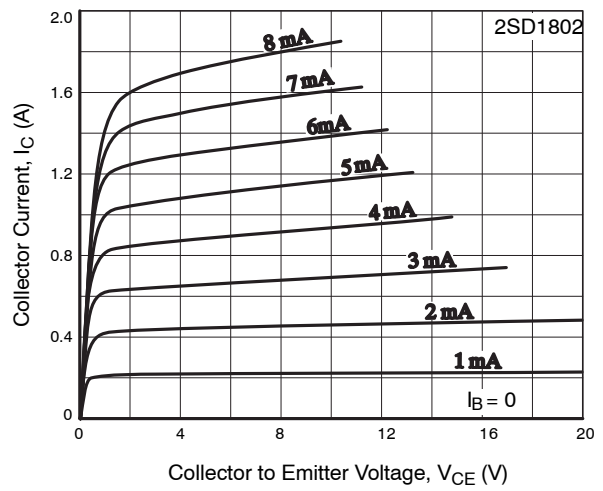
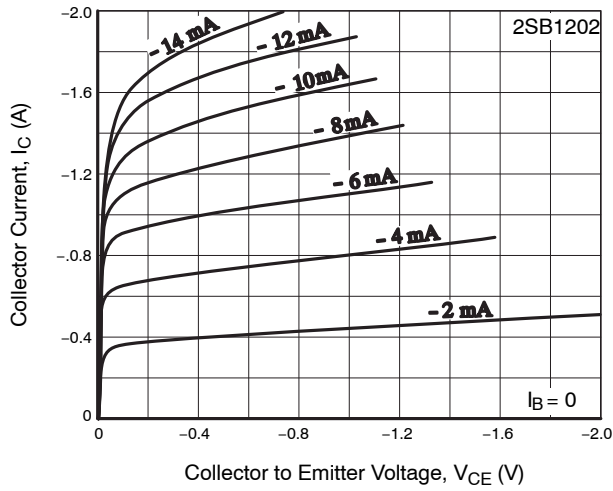
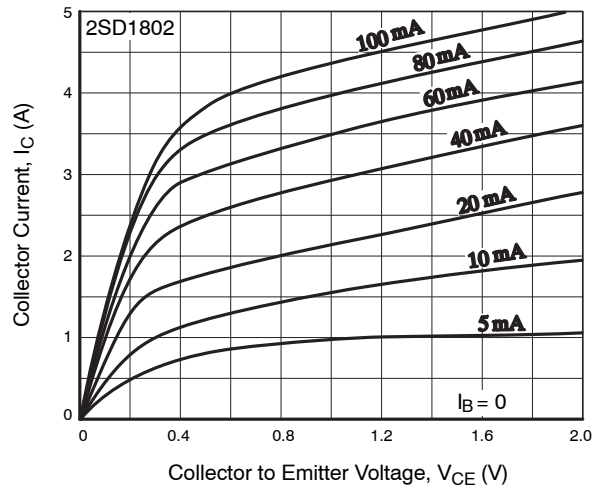
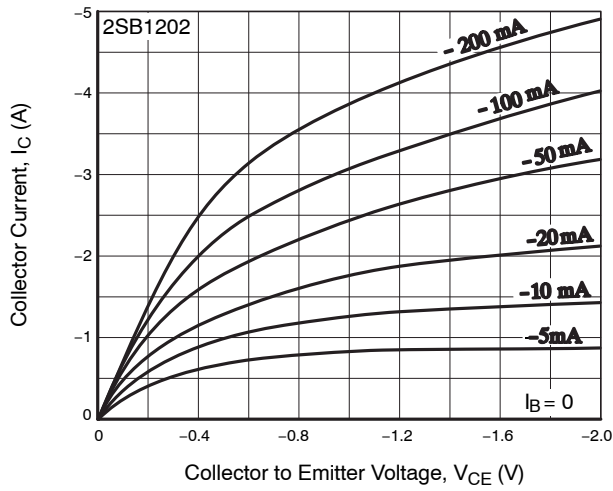
Switching Time Test Circuit



$I_C = 10\text{ A}, I_{B1} = -10\text{ A}, I_{B2} = 1\text{ A}$
For PNP, the polarity is reversed.

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TYPICAL CHARACTERISTICS



2SB1202/2SD1802

TYPICAL CHARACTERISTICS (continued)

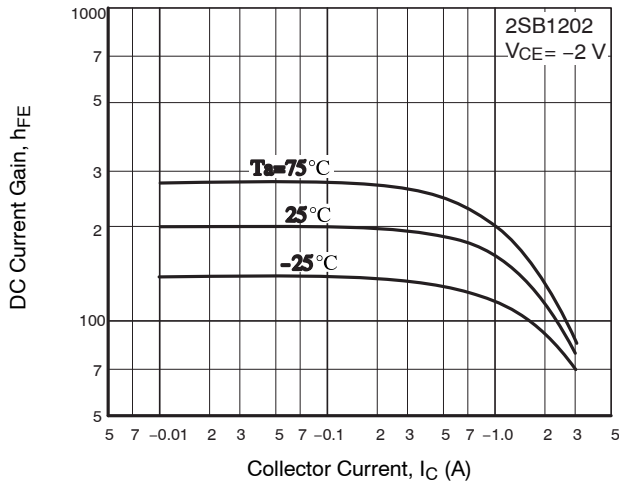


Figure 7. $h_{FE} - I_C$

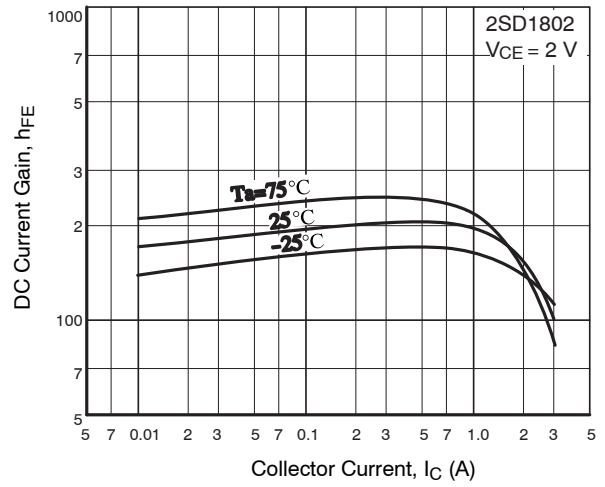


Figure 8. $h_{FE} - I_C$

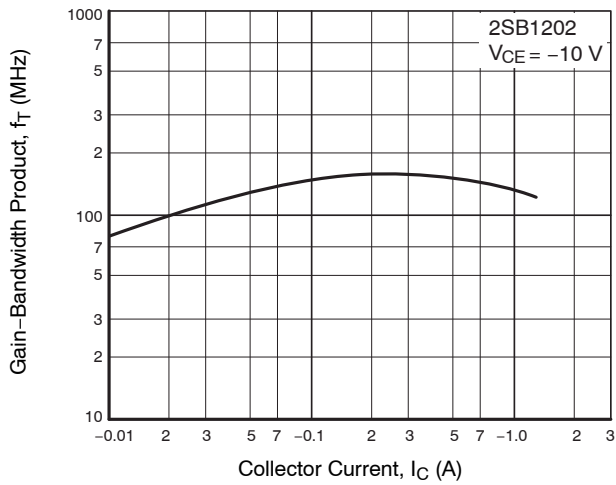


Figure 9. $f_T - I_C$

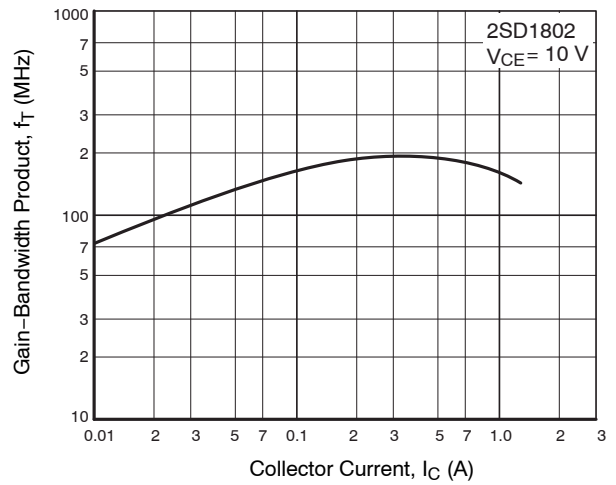


Figure 10. $f_T - I_C$

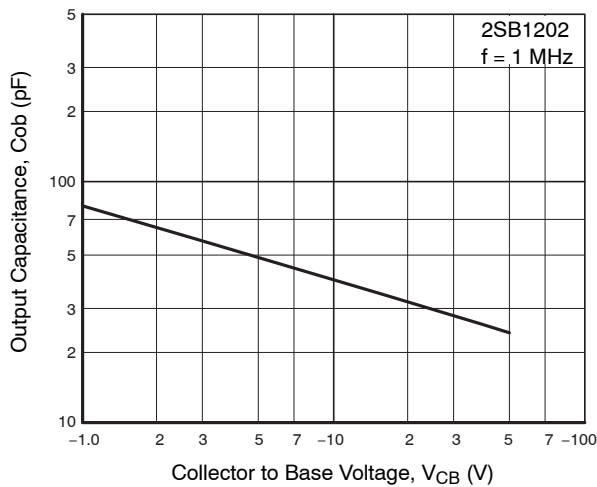


Figure 11. $C_{ob} - V_{CB}$

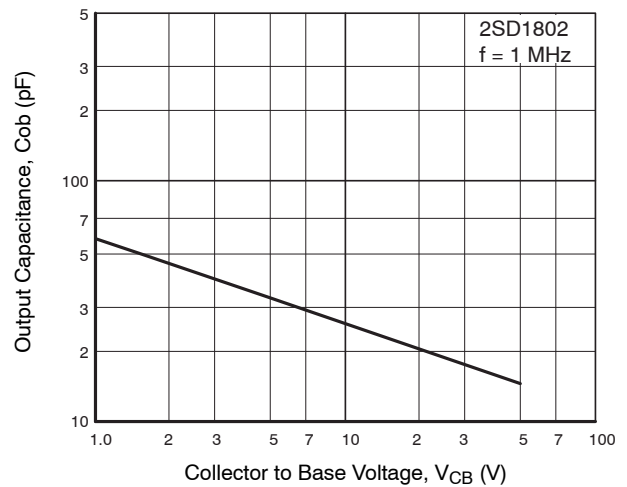


Figure 12. $C_{ob} - V_{CB}$

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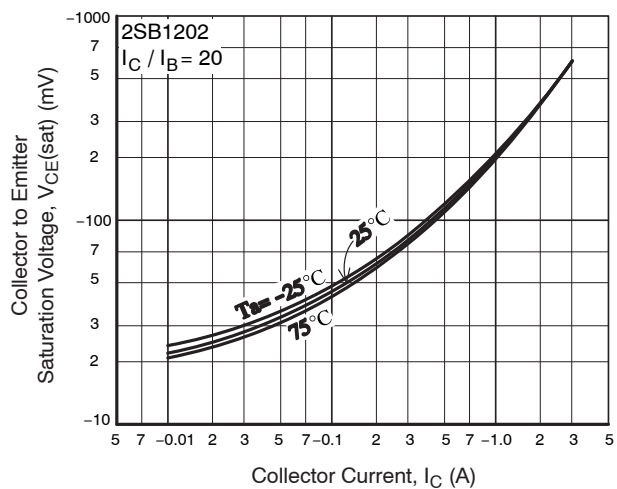


Figure 13. $V_{CE}(sat) - I_C$

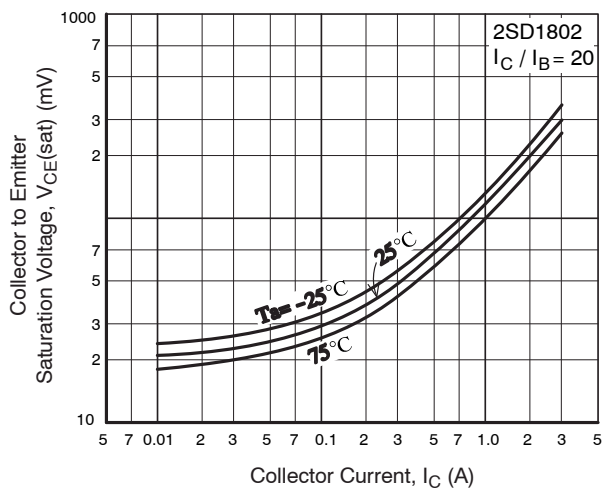


Figure 14. $V_{CE}(sat) - I_C$

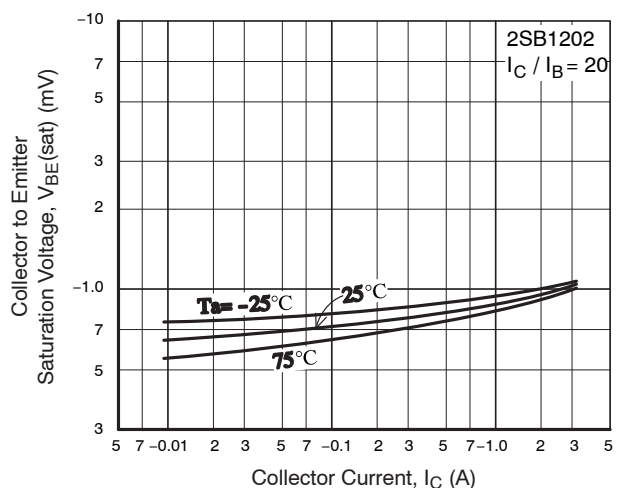


Figure 15. $V_{BE}(sat) - I_C$

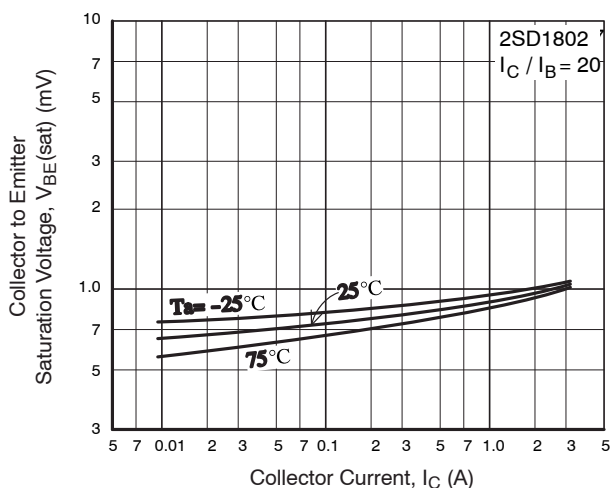


Figure 16. $V_{BE}(sat) - I_C$

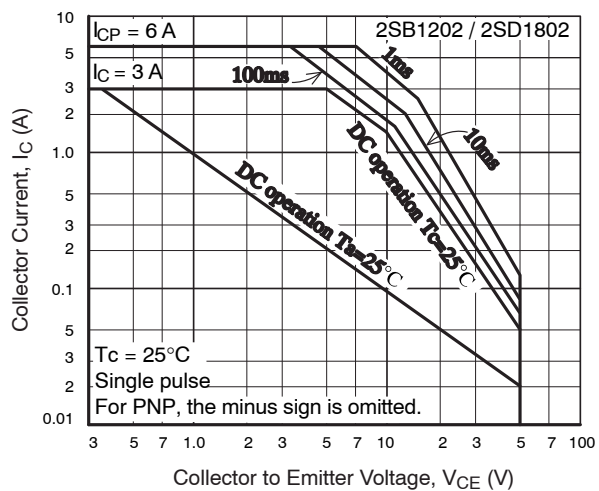


Figure 17. ASO

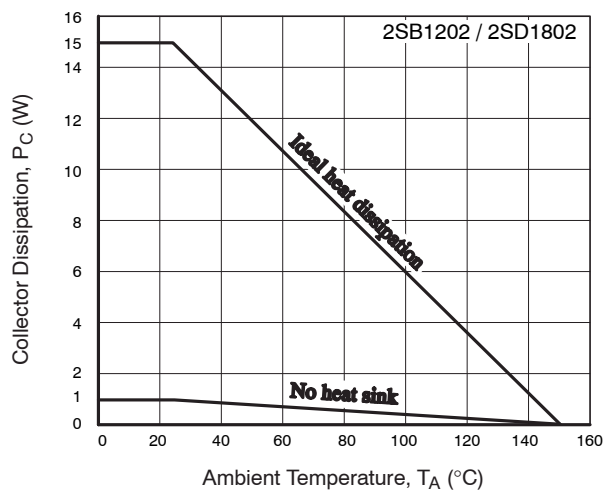


Figure 18. $P_C - T_A$

2SB1202/2SD1802

ORDERING INFORMATION

Device	Package	Shipping†	memo
2SB1202S-E	TP	500pcs./bag	Pb-Free
2SB1202T-E	TP	500pcs./bag	
2SD1802S-E	TP	500pcs./bag	
2SD1802T-E	TP	500pcs./bag	
2SB1202S-TL-E	TP-FA	700pcs./reel	
2SB1202T-TL-E	TP-FA	700pcs./reel	
2SD1802S-TL-E	TP-FA	700pcs./reel	
2SD1802T-TL-E	TP-FA	700pcs./reel	

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MECHANICAL CASE OUTLINE

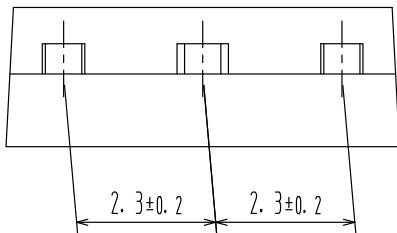
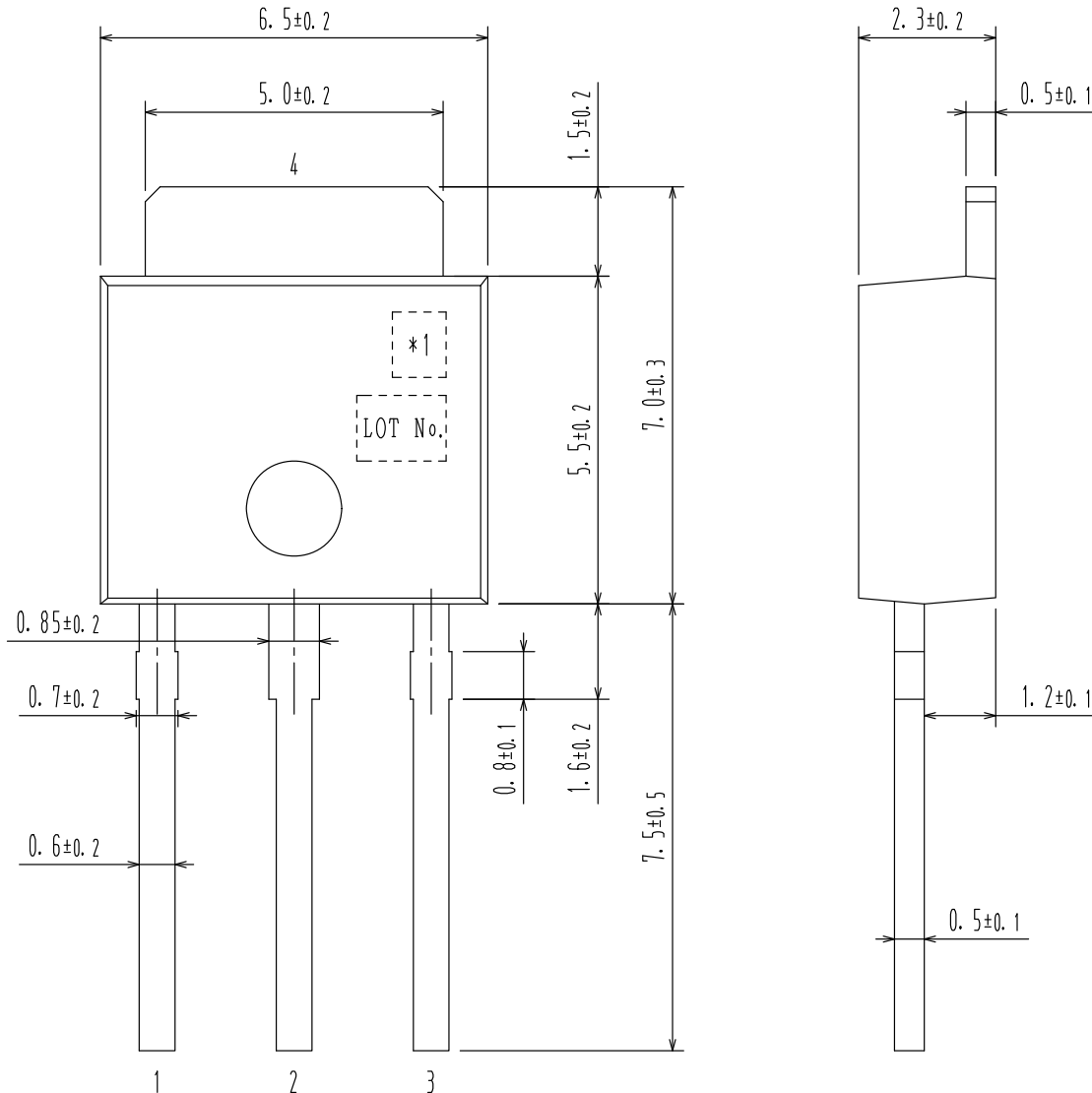
PACKAGE DIMENSIONS

ON Semiconductor®



IPAK / TP
CASE 369AJ
ISSUE O

DATE 30 JAN 2012



- 1:
- 2:
- 3:
- 4:

*1: Lot indication

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